



APTGF90DU60TG

Dual common source NPT IGBT Power Module

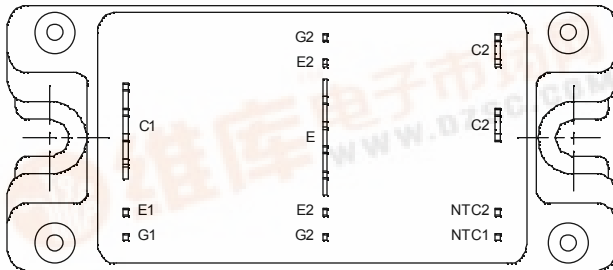
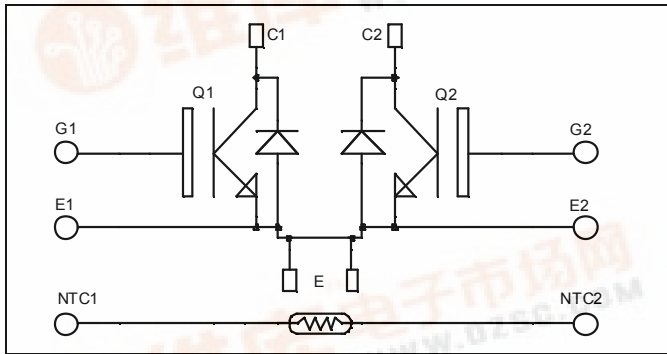
$V_{CES} = 600V$
 $I_C = 90A @ T_c = 80^\circ C$

Application

- AC Switches
- Switched Mode Power Supplies
- Uninterruptible Power Supplies

Features

- Non Punch Through (NPT) Fast IGBT®
 - Low voltage drop
 - Low tail current
 - Switching frequency up to 100 kHz
 - Soft recovery parallel diodes
 - Low diode VF
 - Low leakage current
 - Avalanche energy rated
 - RBSOA and SCSOA rated
 - Kelvin emitter for easy drive
 - Very low stray inductance
 - Symmetrical design
 - Lead frames for power connections
 - Internal thermistor for temperature monitoring
 - High level of integration
- ### Benefits
- Outstanding performance at high frequency operation
 - Stable temperature behavior
 - Very rugged
 - Direct mounting to heatsink (isolated package)
 - Low junction to case thermal resistance
 - Solderable terminals both for power and signal for easy PCB mounting
 - Easy paralleling due to positive TC of VCEsat
 - Low profile
 - RoHS compliant



Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V_{CES}	Collector - Emitter Breakdown Voltage	600	V
I_C	Continuous Collector Current	$T_c = 25^\circ C$	A
		$T_c = 80^\circ C$	
I_{CM}	Pulsed Collector Current	$T_c = 25^\circ C$	315
V_{GE}	Gate - Emitter Voltage	± 20	V
P_D	Maximum Power Dissipation	$T_c = 25^\circ C$	416
RBSOA	Reverse Bias Safe Operating Area	$T_j = 150^\circ C$	200A @ 600V

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
I_{CES}	Zero Gate Voltage Collector Current	$V_{GE} = 0\text{V}$ $V_{CE} = 600\text{V}$	$T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$			250 500	μA
$V_{CE(sat)}$	Collector Emitter saturation Voltage	$V_{GE} = 15\text{V}$ $I_C = 90\text{A}$	$T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$		2.0 2.2	2.5	V
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}, I_C = 1\text{mA}$		3		5	V
I_{GES}	Gate – Emitter Leakage Current	$V_{GE} = 20\text{V}, V_{CE} = 0\text{V}$				± 150	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
C_{ies}	Input Capacitance	$V_{GE} = 0\text{V}$			4300		pF
C_{oes}	Output Capacitance	$V_{CE} = 25\text{V}$			470		
C_{res}	Reverse Transfer Capacitance	$f = 1\text{MHz}$			400		
Q_g	Total gate Charge	$V_{GE} = 15\text{V}$			330		nC
Q_{ge}	Gate – Emitter Charge	$V_{Bus} = 300\text{V}$			290		
Q_{gc}	Gate – Collector Charge	$I_C = 90\text{A}$			200		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (25°C)			26		ns
T_r	Rise Time	$V_{GE} = 15\text{V}$			25		
$T_{d(off)}$	Turn-off Delay Time	$V_{Bus} = 400\text{V}$			150		
T_f	Fall Time	$I_C = 90\text{A}$ $R_G = 5\ \Omega$			30		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (125°C)			26		ns
T_r	Rise Time	$V_{GE} = 15\text{V}$			25		
$T_{d(off)}$	Turn-off Delay Time	$V_{Bus} = 400\text{V}$			170		
T_f	Fall Time	$I_C = 90\text{A}$ $R_G = 5\ \Omega$			40		
E_{on}	Turn-on Switching Energy	$V_{GE} = 15\text{V}$ $V_{Bus} = 400\text{V}$	$T_j = 125^\circ\text{C}$		4.3		mJ
E_{off}	Turn-off Switching Energy	$I_C = 90\text{A}$ $R_G = 5\ \Omega$	$T_j = 125^\circ\text{C}$		3.5		

Reverse diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
V_{RRM}	Maximum Peak Repetitive Reverse Voltage			600			V
I_{RM}	Maximum Reverse Leakage Current	$V_R = 600\text{V}$	$T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$			350 600	μA
I_F	DC Forward Current		$T_c = 70^\circ\text{C}$		60		A
V_F	Diode Forward Voltage	$I_F = 60\text{A}$			1.6	1.8	V
		$I_F = 120\text{A}$			1.9		
		$I_F = 60\text{A}$	$T_j = 125^\circ\text{C}$		1.4		
t_{rr}	Reverse Recovery Time	$I_F = 60\text{A}$ $V_R = 400\text{V}$		$T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$	85 160		ns
Q_{rr}	Reverse Recovery Charge	$di/dt = 400\text{A}/\mu\text{s}$		$T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$	260 1400		nC

Thermal and package characteristics

Symbol	Characteristic			Min	Typ	Max	Unit
R _{thJC}	Junction to Case Thermal Resistance			IGBT		0.3	°C/W
				Diode		0.65	
V _{ISOL}	RMS Isolation Voltage, any terminal to case t =1 min, I isol<1mA, 50/60Hz			2500			V
T _J	Operating junction temperature range			-40		150	°C
T _{STG}	Storage Temperature Range			-40		125	
T _C	Operating Case Temperature			-40		100	
Torque	Mounting torque	To Heatsink	M5	2.5		4.7	N.m
Wt	Package Weight					160	g

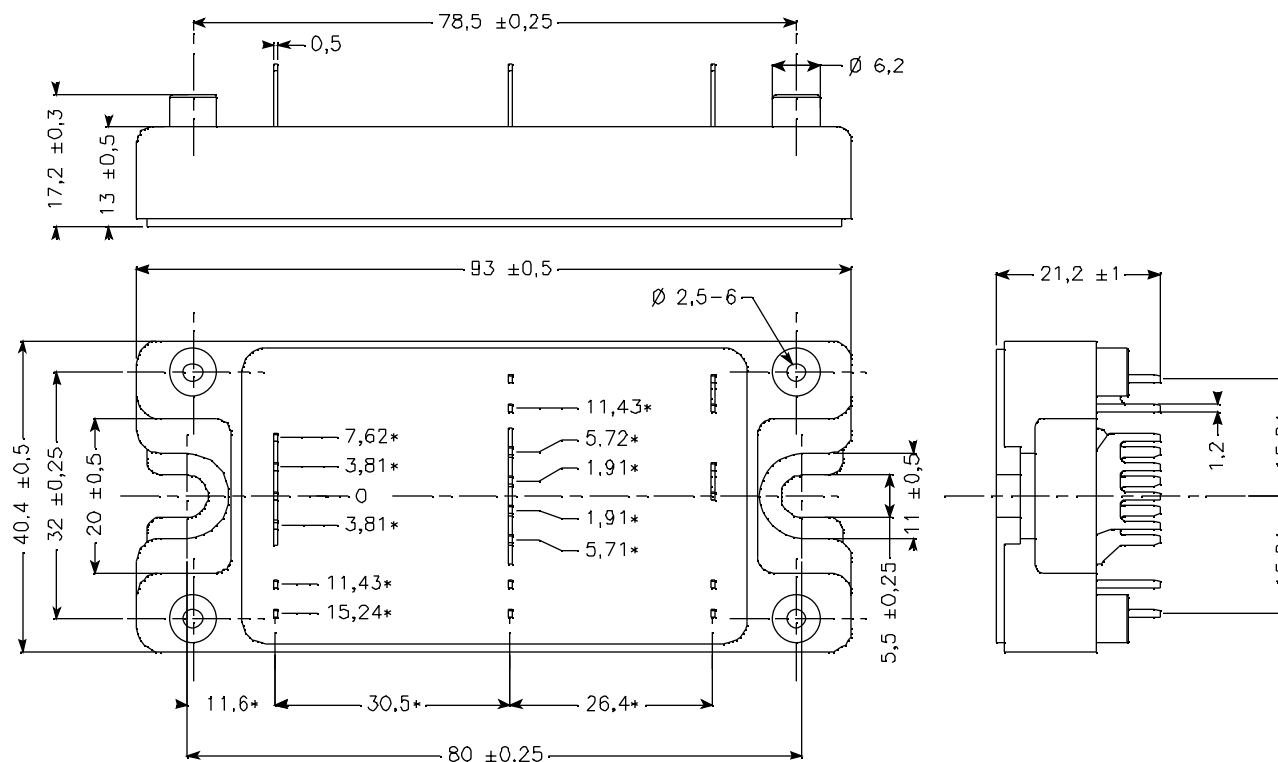
Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

Symbol	Characteristic	Min	Typ	Max	Unit
R ₂₅	Resistance @ 25°C		50		kΩ
B _{25/85}	T ₂₅ = 298.15 K		3952		K

$$R_T = \frac{R_{25}}{\exp \left[B_{25/85} \left(\frac{1}{T_{25}} - \frac{1}{T} \right) \right]}$$

T: Thermistor temperature
 R_T: Thermistor value at T

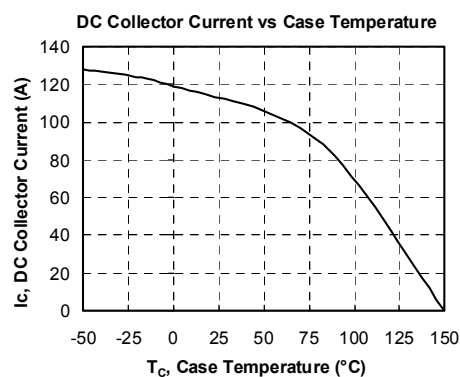
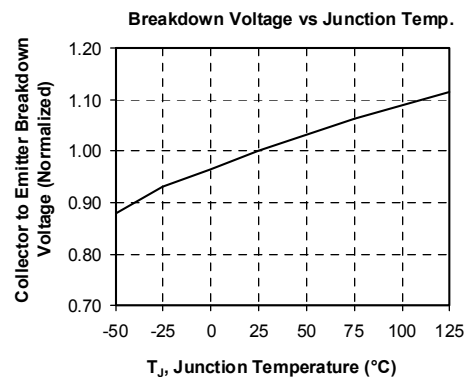
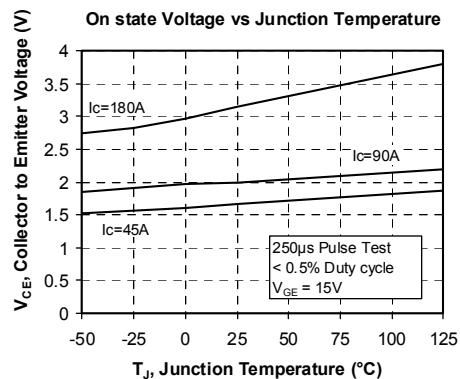
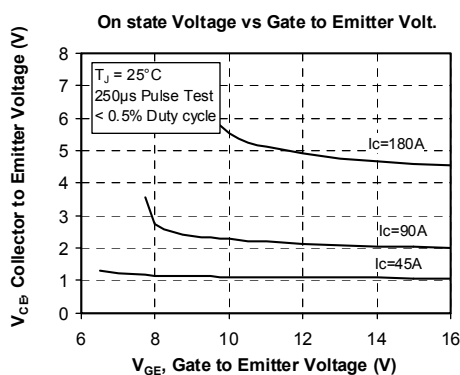
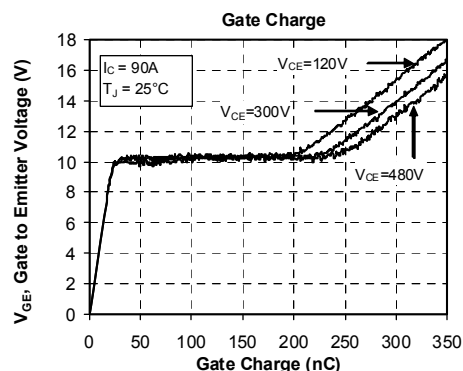
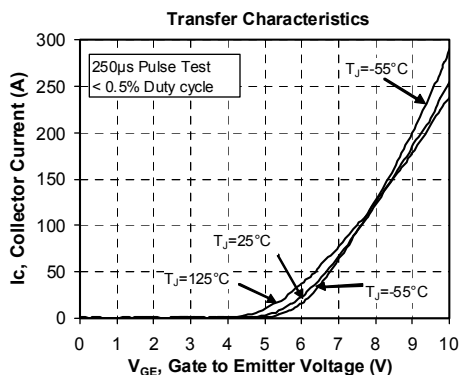
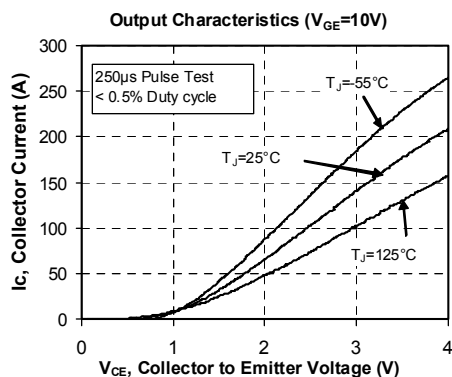
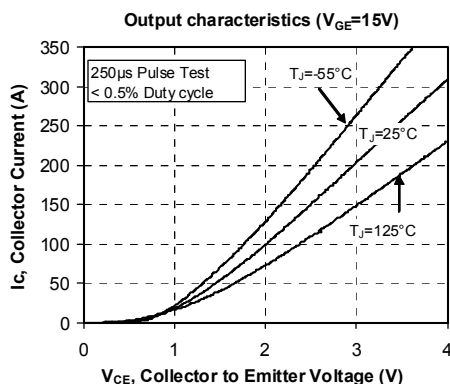
SP4 Package outline (dimensions in mm)

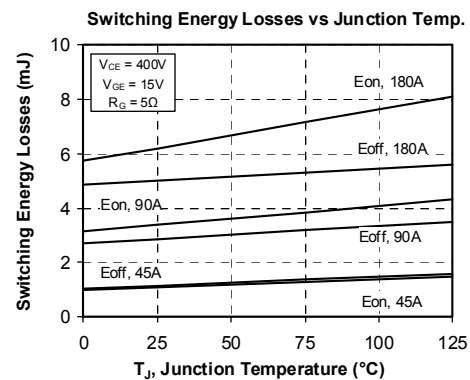
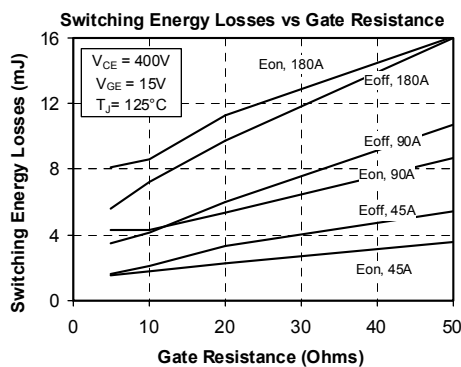
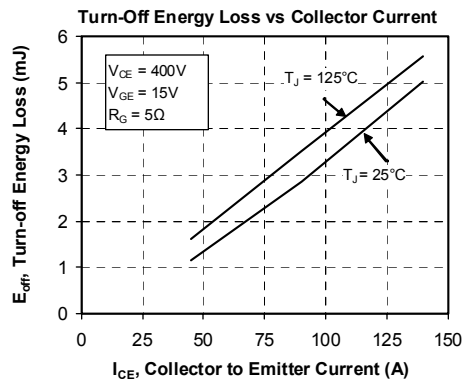
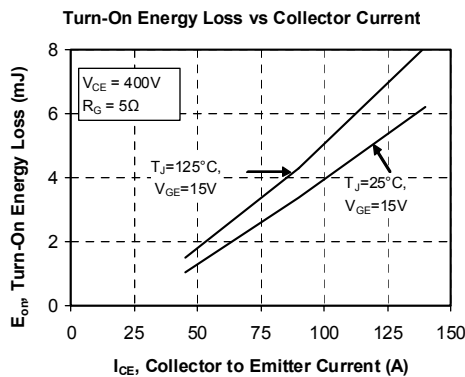
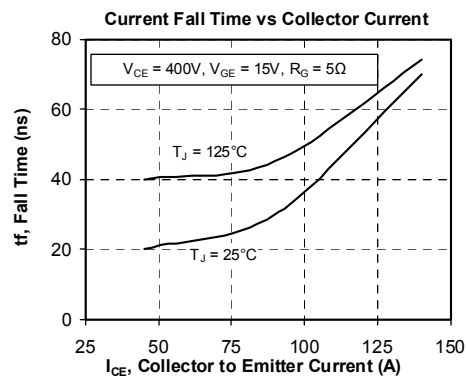
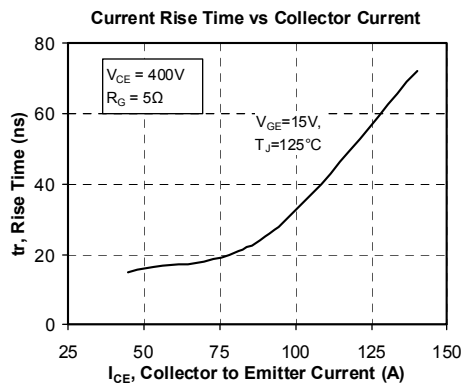
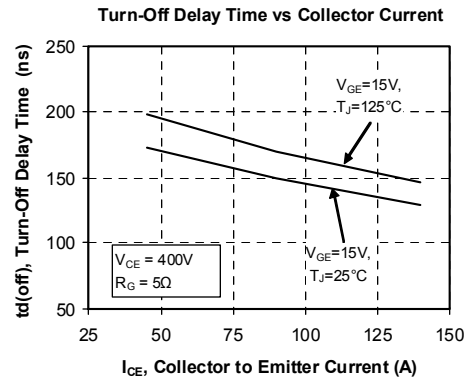
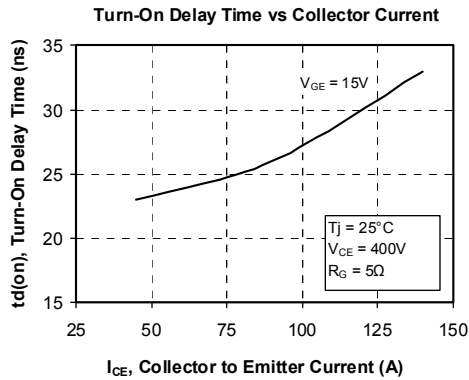


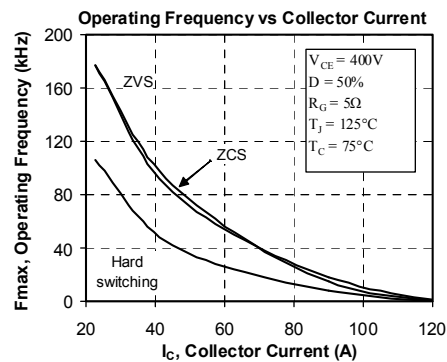
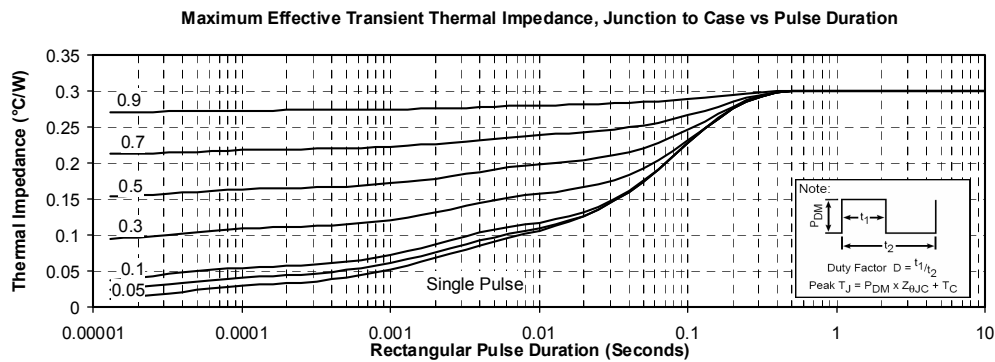
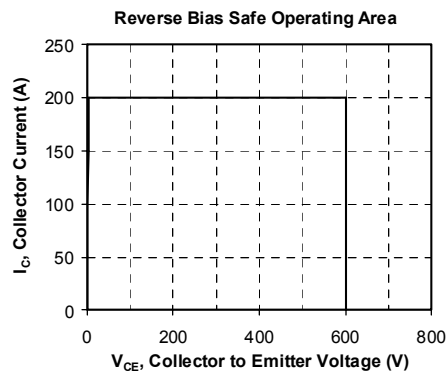
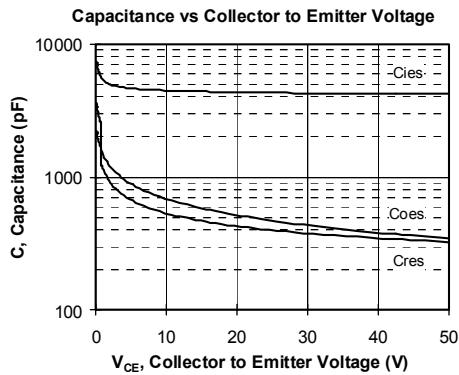
ALL DIMENSIONS MARKED "*" ARE TOLERENCED AS: ± 0.1

See application note APT0501 - Mounting Instructions for SP4 Power Modules on www.microsemi.com

Typical Performance Curve







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Microsemi's products are covered by one or more of U.S. patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. U.S. and Foreign patents pending. All Rights Reserved.